

TFE (Total Solution Provider) For The Ultimate Solution On

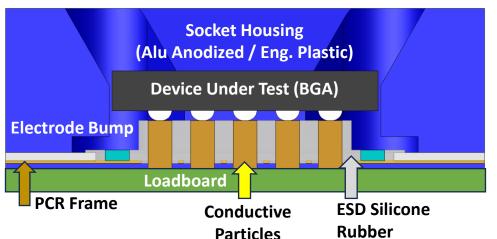
High-Speed & Cost-Effective Testing.

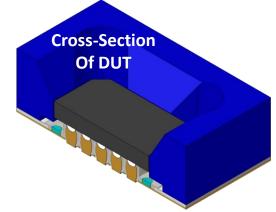
Understanding TFE/JMT's PCR Rubber Contact



PCR: Pressure Sensitive Anisotropic Conductive Rubber, suitable for a Broad Array of IC Test Applications

How A PCR Test Socket Works

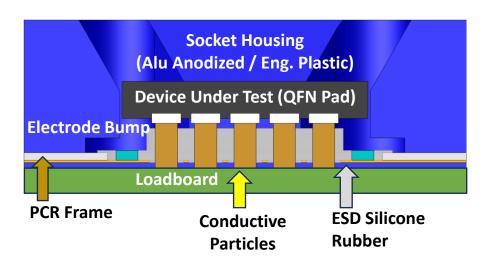


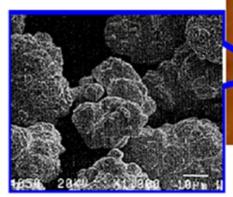


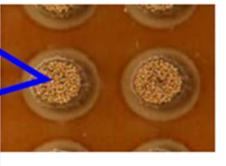
PCR contacts form a snug, non-invasive connection with BGA components during testing.

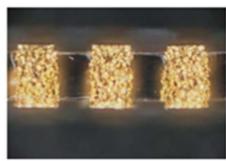
Their unique design allows them to gently conform to the BGA's solder balls, ensuring reliable electrical contact without damaging the delicate connections.

This approach enhances the precision and safety of BGA/QFN or any Leadless Packages testing.









Conductive Particles

PCR's Cross-Section

The Fundamentals Of PCR Technology

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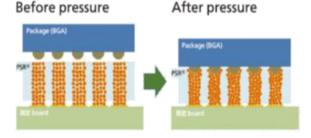
Unique Selling Proposition (USP):

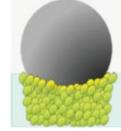
TFE/JMT's USP lies in its pioneering spirit and consistent innovation in elastomeric connectors.

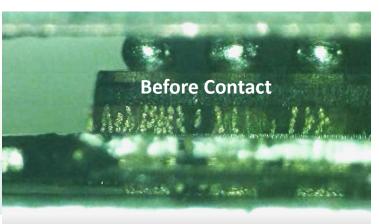
It stands as the original inventor of the Rubber Socket, a breakthrough that has set industry standards for over three decades.

Multiple Points Contact Structure

Image of Structure



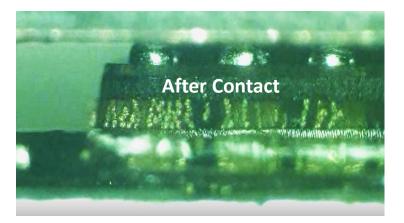




PCR is a product including conductive micro particles aligned at regular intervals.

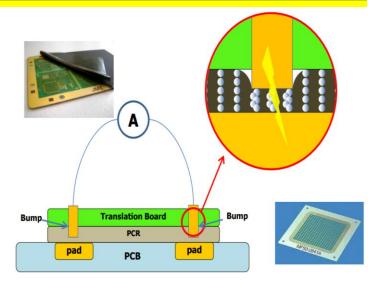
Pressure on the top surface will cause a connection from top to bottom through the PCR with no risk of shorting or leakage to surrounding particles.

Areas with no force applied will not cause contact through the PCR.



PCR's Cross-Section During Contact

Board-To-Board (BTB) Interposer/Interconnect



While many of our competitors primarily focus on the final test application, TFE's innovative engineering team does not limit itself to just one specific application; Instead, we excel in a diverse range of applications, with interconnect applications being just one of our many specialties.

PCR's Electrical Specification:



Rigorous Quality Control processes ensure that TFE/JMT's elastomer contacts meet the highest industry standards, reinforcing its reputation for excellence.

Pitch	P0.30mm	P0.35mm	P0.40mm	P0.50mm	P0.65mm	P0.80mm
Total Thickness	0.45mm	0.45mm	0.55mm	0.75mm	0.8mm	0.9mm
Electrode Diameter	φ0.18mm	φ0.21mm	φ0.23mm	φ0.3mm	φ0.38mm	φ0.45mm
Insertion Loss	96 GHz (@ -1 dB)	>100 GHz (@ -1 dB)	91 GHz (@ -1 dB)	108 GHz (@ -1 dB)	62 GHz (@ -1 dB)	37 GHz (@ -1 dB)
Return Loss	44 GH z (@ -10 dB)	43 GHz (@ -10 dB)	99 GHz (@ -10 dB)	>110 GHz (@ -10 dB)	43 GHz (@ -10 dB)	23 GHz (@ -10 dB)
Inductance	0.09 nH (@ 1 GHz)	0.10 nH (@ 1 GHz)	0.12 nH (@ 1 GHz)	0.17 nH (@ 1 GHz)	0.16 nH (@ 1 GHz)	0.19 nH (@ 1 GHz)
Capacitance	0.06 pF (@ 1 GHz)	0.09 pF (@ 1 GHz)	0.08 pF (@ 1 GHz)	0.11 pF (@ 1 GHz)	0.20 pF (@ 1 GHz)	0.23 pF (@ 1 GHz)
**Contact Force (g/pin)	8	10	12	15	20	25
Contact Resistance	50 mOhm	50 mOhm	50 mOhm	50 mOhm	50 mOhm	30 mOhm
Max Current	2.5 A	2.5 A	3.0 A	3.5 A	5.0 A	7.0 A

^{**} Insertion Loss Contact Force can be customized according to applications

Overcome Device Warpages with Advanced Technology

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Profile Elastomer Sockets Overview

- •Overview: Essential for semiconductor testing, especially for large device packages.
- •Problem: Warpage from thermal and mechanical stresses compromises contact reliability during testing.
- •Objective: Highlight why Profile PCR Elastomer sockets effectively address warpage challenges in large device packages.

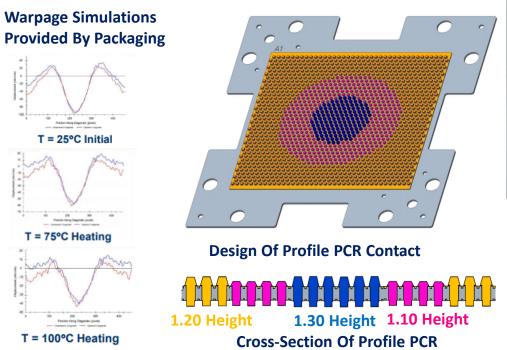
Advantages of Profile Elastomer Sockets

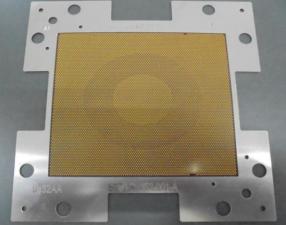
- •High Compliance: Adapts to irregularities and warpage in large devices without affecting electrical connections.
- •Durability: Resilient material ensures reliable performance under repeated stress.
- •Optimized Force: Minimal contact force reduces risk of damage during insertion and removal.

Profile PCR's Precision Design

The zoomed-in view of TFE's Profile PCR reveals precision-engineered bump height variations, customized to match user-provided warpage simulations.

This profiling compensates for warpage, ensuring reliable contact and optimizing testing accuracy and device performance.





Physical Profile PCR Contact

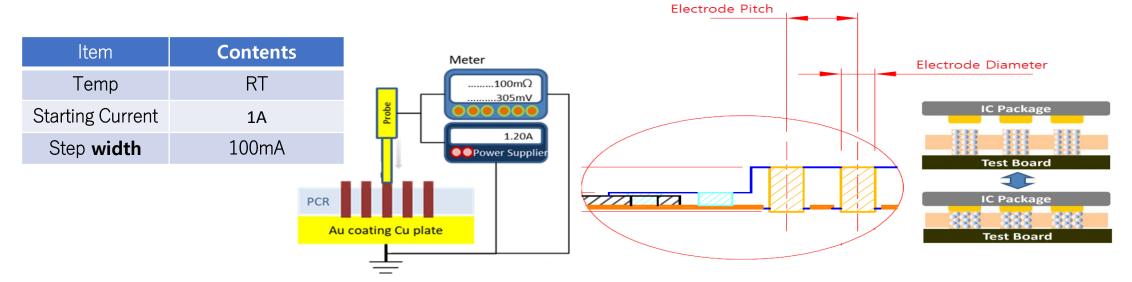


Profile PCR Contact Electrodes

PCR Rubber Contact Current Rating Capacity

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For Power Applications



Electrode Pitch (mm)	Electrode Diameter (um)	Electrode Height (μ)	Max. Current Carrying Capacity (Till Burnt)	Recommended Current Rating
0.30mm	ф200	450t	2.5A	1.25A
0.40mm	ф230	550t	3A	1.5A
0.50mm	ф300	750t	3A	1.5A
0.65mm	ф380	800t	5A	2.5A
0.80mm	ф450	900t	7A	3.5A
1.00mm	ф500	900t	8A	4A

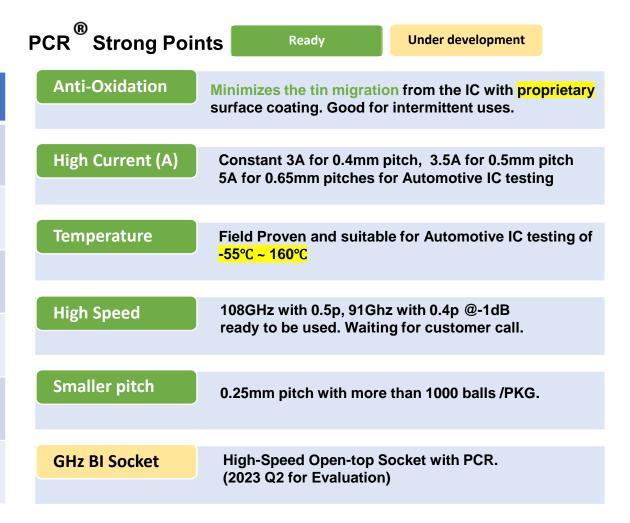
Advantages Of PCR:



While competitors offer similar products, JMT differentiates itself through its legacy, technological advancements, and product quality

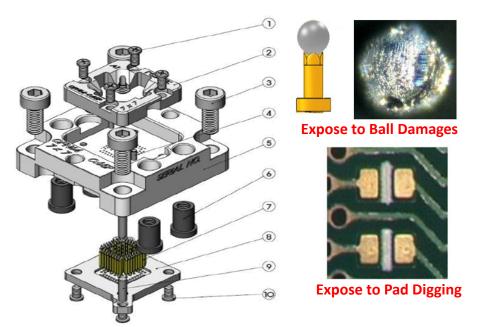
Comparison PCR Rubber VS Spring Pin

	PCR®	Spring-pin	Co-Axial
Ball / PCB pad Damage	No	Yes	Yes
Test Frequency S21@-1dB	Up to 91Ghz (@ 0.4mm)	10GHz or less	30GHz or more
Contact Pitch (mm)	0.27mm~1.27mm (ready for 0.2)	0.15 ~	0.8~1.27
Cleaning Frequency	Few	Often	Often
Lifespan (Insertions)	~ 150K	150 ~ 300K	Less 20K
Cost per Pin Cost-Effective		High	Very High



Advantages of PCR Sockets Over Conventional Pogo Pin Sockets.

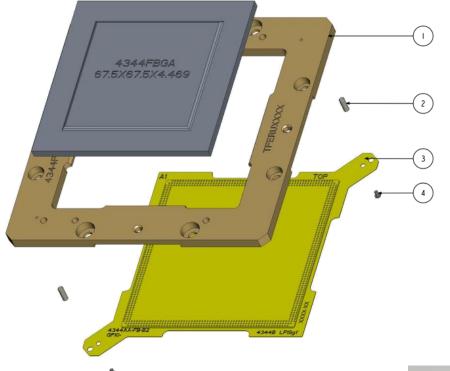


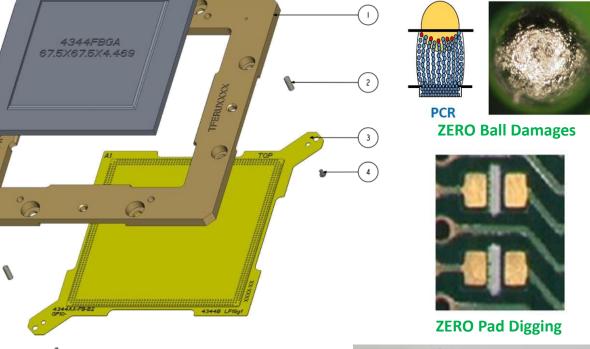


Conventional Spring Pin Test Socket

Disadvantages:

- Multiple Structure that requires all part's tolerance to be within
- High Cost due to multi-parts and pins
- Long change over time

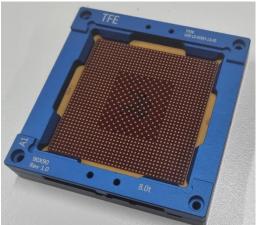




TFE / JMT PCR Elastomar Test Socket

Advantages:

- Simple Structure socket housing
- Very Cost Effective
- Very fast change over time



PCR Open-Top Sockets Application.

The PCR is offered in an **Open-Top design**, providing significant advantages over conventional open-top sockets.

Key benefits:

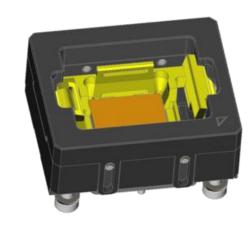
Includes the ability to reuse the open-top body by replacing only the PCR as a consumable spare, thereby reducing maintenance costs.

Additionally, this design eliminates the risk of PCB pad damage, as it avoids the soldering or desoldering required with receptacle-type opentop sockets.

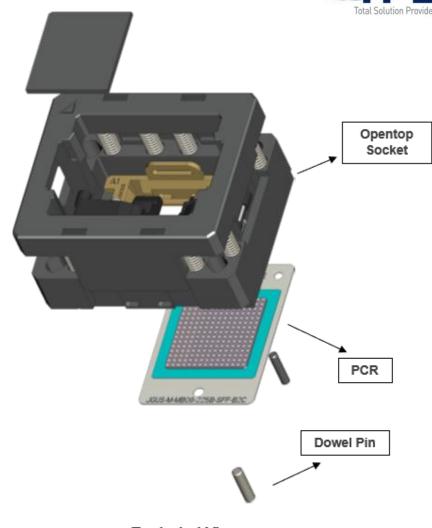
Furthermore, it ensures zero damage to the contact pads of QFN and LGA devices, or the solder balls in BGA arrays, maintaining device integrity and reliability throughout testing.



Free-State



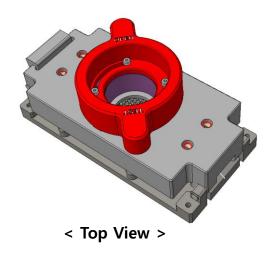
Test-State

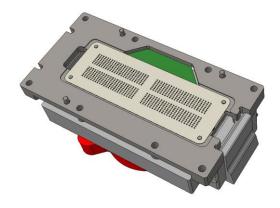


Exploded View

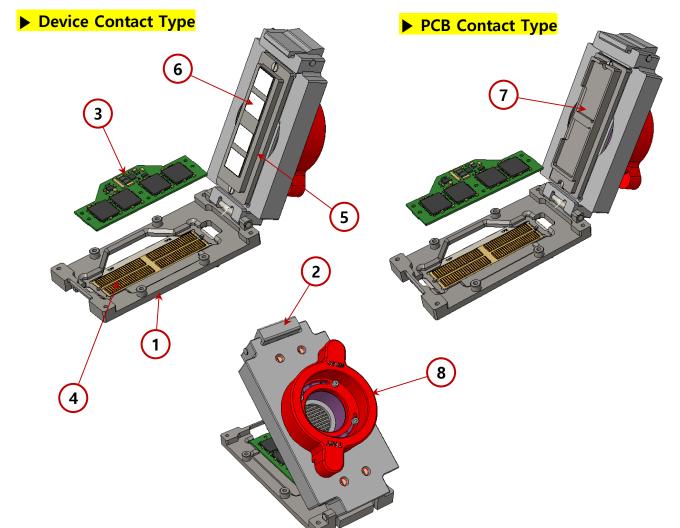
LPCAMM PCR Test Socket For Manual Test / System Level Testing







< Bottom View >

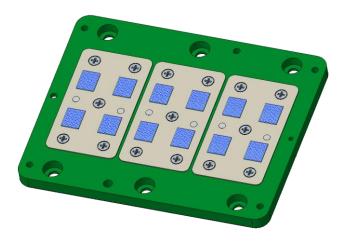


BOM:

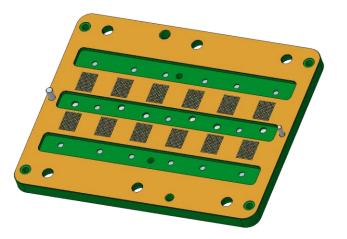
- ① Socket Guide
- ② Manual Socket Housing
- **③ Test Product**
- **4** Rubber Socket
- ⑤ Device Contact Pusher (Heat Sink)
- 6 Silicone(0.3T)(Device Protection)
- PCB Contact Pusher (Heat Sink)
- Manual Knob

TFE Rubber Contact: The Ideal Solution For WLBGA Applications





Top View



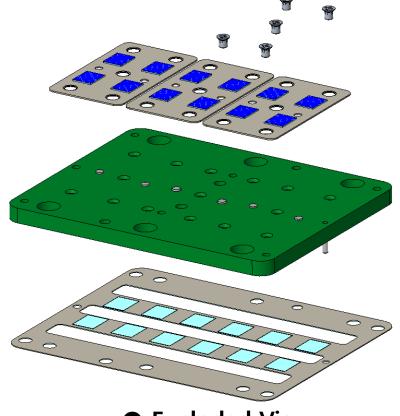
Bottom View

Advantages of using TFE rubber in Wafer-Level Chip Scale Package (WLCSP) technology.

WLCSP is favored for its compact design and costeffectiveness, but handling small Ball Grid Arrays (BGAs) with tight pitches can pose challenges such as ball damage, missing balls, and loadboard issues.

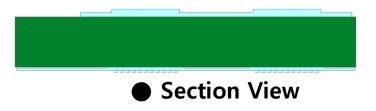
TFE rubber's unique properties make it an ideal solution for WLCSP, allowing for precise small BGA handling without damage, preventing missing balls, protecting loadboards, and enabling low-force handling.

This results in a High First-Pass Yield, reducing costs and increasing the reliability of WLCSP components, making it a valuable choice for the semiconductor Final Test.



Exploded View



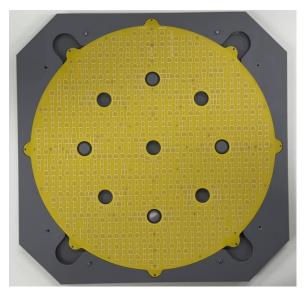


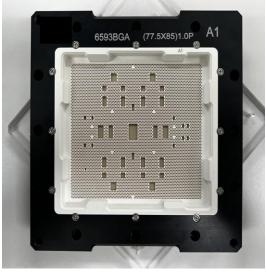
Pogo Pin Test Socket Solution

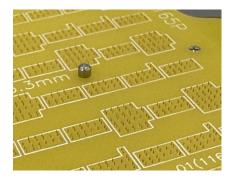
Provides high-quality sockets, including test pins

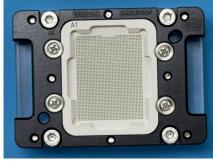
- . System Level Test Socket
- . RF Device Test Socket
- . Large Device Test Socket
- . Memory Device Test Socket
- . High Bandwidth Memory Socket
- . Burn In Socket













Camera Module Socket

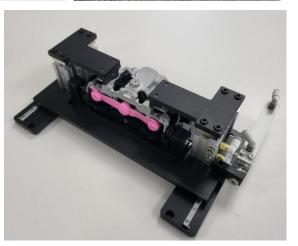
- . Auto Test Socket
- . Manual Test Socket
- . Customize to needs
- . Un-conventional design with innovation













Testing BGA, LGA, QFN Package, Camera Module, LCD Module, etc.

- . Pogo Pin down to 0.18mm pin pitch
- . Rubber Socket down to 0.2mm pin pitch
- . Stamping Pin down to 0.15mm pin pitch

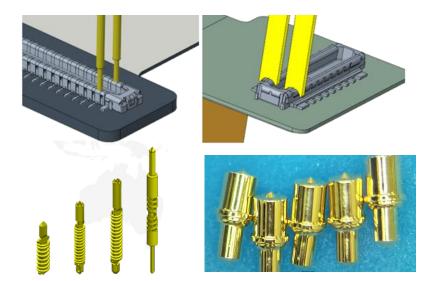


GENERAL Standard Of Test Socket

- . Camera Module
- . PCB
- . System Interface
- . LCD / OLED / LED

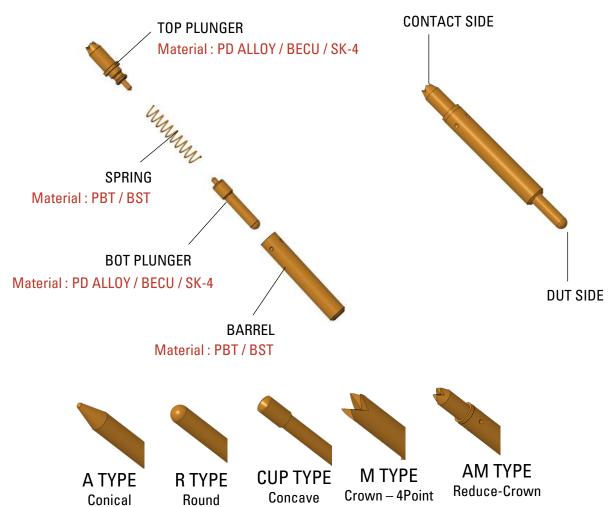


- . Memory
- . Logic
- . HBM
- . WLCSP



POGO PIN – down to 0.18mm pin pitch

- Double PIN
- Single PIN





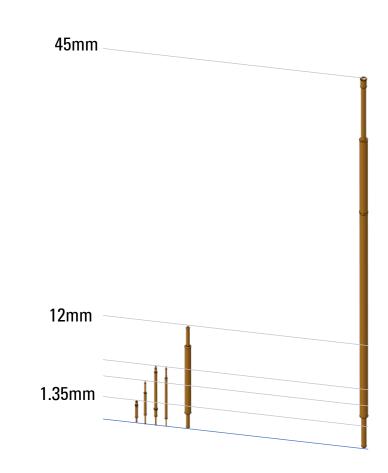


High Speed Pin

ITEM	General specifications	
Body Diameter	Ф0.22mm ~	
Probe Length	1.35mm ~	
Plunger Material	BeCu / SK-4 / Pd-Alloy	
Plating	Au, Rhodium, Pd Plating	

Fine Pitch Pin

ITEM	General specifications	
Body Diameter	Ф0.13mm ~ Ф0.3mm	
Probe Length	2.0mm ~	
Plunger Material	BeCu / SK-4 / Pd-Alloy	
Plating	Au, Rhodium, Pd Plating	



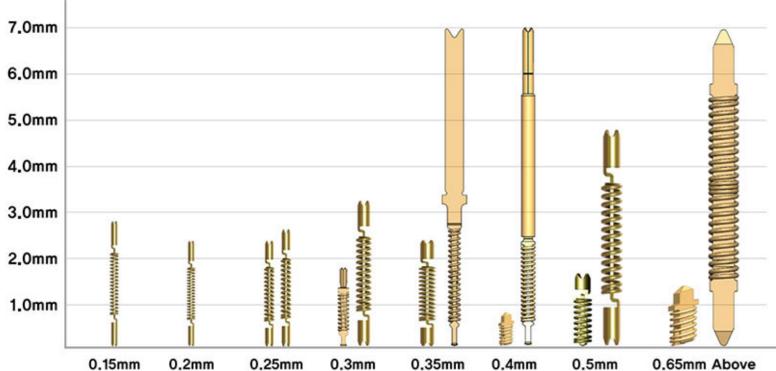


Stamping Pin – down to 0.15mm pin pitch

Can be shorter

Touch down unstable signal

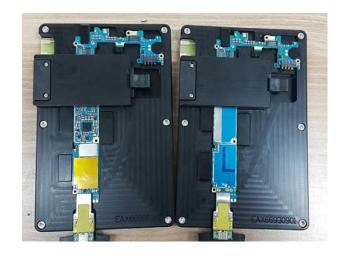
Ordinary POGO New Technology Signal path stable 7.0mm 6.0mm 5.0mm



Customization by customer request















TFE Board Saver: The Ideal Solution For Loadboard Digging Occurences



Existing Footprint

< BOTTOM VIEW >

Board Saver: Effective and Efficient Loadboard Pad Protection

Introduction:

BoardSaver emerges as the ideal solution for safeguarding loadboard pads from digging in semiconductor testing. This concise technical overview outlines why BoardSaver offers a costeffective and optimal approach to prevent pad damage.

Cost-Effective Advantage:

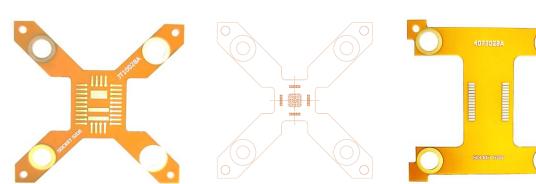
BoardSaver's proactive design eliminates the need for frequent pad replacements and repairs, reducing long-term operational costs. Preventing pad damage upfront curtails unplanned downtime and maintenance expenses.

Optimal Protection Mechanism:

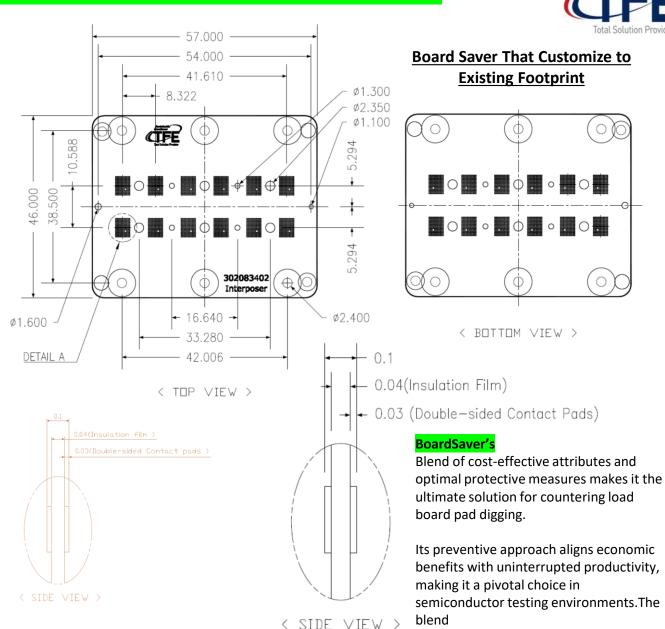
Through meticulous engineering and robust material selection, **BoardSaver** creates a resilient shield against mechanical stress and abrasion during testing. Its even force distribution minimizes stress concentrations that lead to pad digging, ensuring optimal protection.

Value and ROI:

BoardSaver leads to enhanced loadboard pad longevity, minimizing replacement frequency and associated costs. This results in improved operational efficiency, reduced maintenance costs, and higher returns on investment.



Examples Of Board Saver



PCR Cleaning Procedure and Tools



Cleaning Wands with tacky Polyurethane tips are effective at removing foreign particles from PCR surfaces

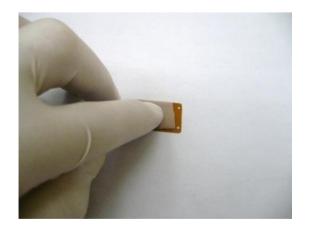
- Use repeatedly by washing with water
- Select the tip shape according to the application







Cellophane tape can also be used to clean PCR





- ➤ Ingredients: Polyurethane (99.9%) (plasticizer free)
- > GHS classification
 - Physical and chemical hazards: Not applicable
 - Health hazards: Not applicable
 - Environmental hazards: Not applicable
- > RoHS compliant

